

3.2x2.8mm PLCC4 SMD LED

Features

• Ideal for indication light on hand held products

Long life and robust package

• Standard Package: 2000pcs/ Reel

• MSL (Moisture Sensitivity Level): 3

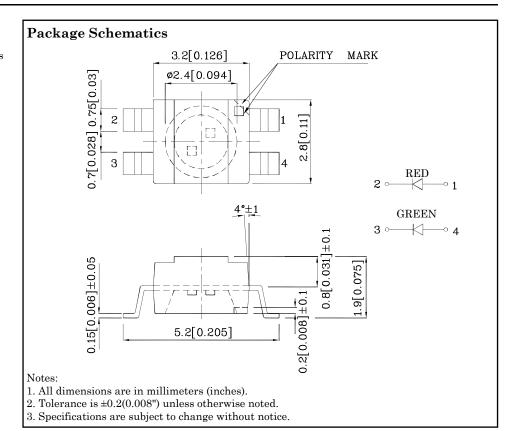
• RoHS compliant.

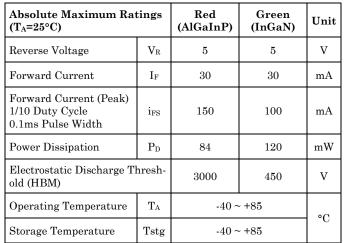






ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES





A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Red (AlGaInP)	Green (InGaN)	Unit
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.2	3.2	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.8	4	V
Reverse Current (Max.) $(V_R=5V)$	I_R	10	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =20mA)	λP	640*	520*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	625*	525*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	20	35	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	27	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} Luminous\ Intensity \\ CIE127\text{-}2007* \\ (I_F\text{=}20\text{mA}) \\ mcd \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZM2CRKM2DG45WT-9 —	Red	AlGaInP	- Water Clear	1000 300*	1490 447*	640*	120°
	Green	InGaN		1000 1000*	1590 1590*	520*	

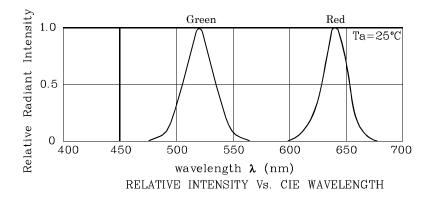
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. AUG 09,2016

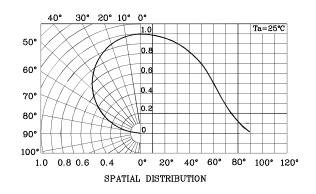
XDSB8751 V1-X Layout: Maggie L.

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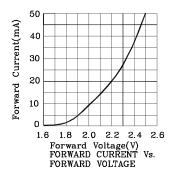


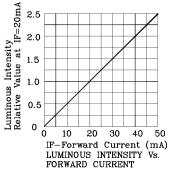
www.SunLEDusa.com

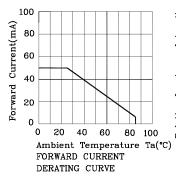


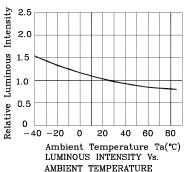


❖ Red

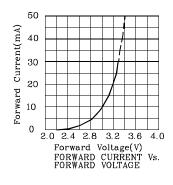


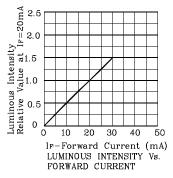


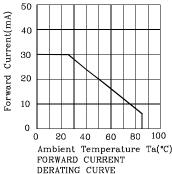


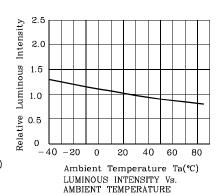


♦ Green







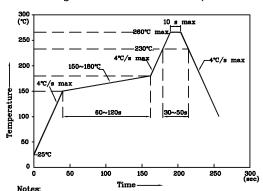






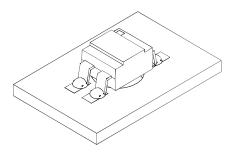
LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

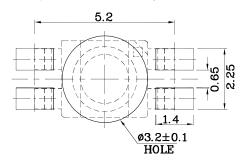


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

♦ The device has a single mounting surface. The device must be mounted according to the specifications.



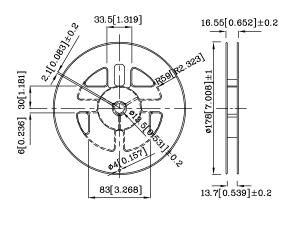
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Tape Specification (Units:mm)

TAPE 4.0±0.1 2.0±0.1 4.0±0.1 0.25±0.1 2.1±0.1 1 4 2 3

♦ Reel Dimension



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

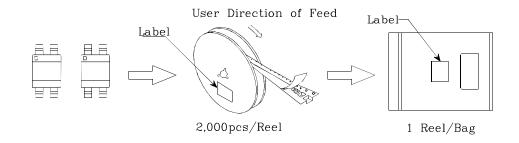
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

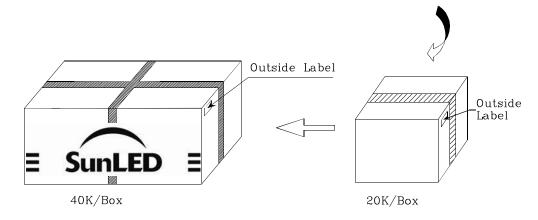
Note: Accuracy may depend on the sorting parameters.

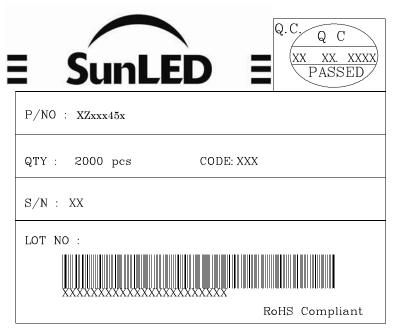




PACKING & LABEL SPECIFICATIONS







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